

In the United States Patent and Trademark Office

Date: HEREWITH
In re Ashima Chakravarti, et al. **Filed:** 1/20/04
Application of:
For: Polycrystalline Silicon Layer With Nano-Grain
Structure And Method of Manufacture
Serial Number: 10/707,878 **Confirmation No.** 1877
Art Unit: 2891 **Examiner:** SMITH, BRADLEY

AMENDMENT AFTER FINAL REJECTION

Hon. Commissioner of Patents and Trademarks
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed October 27, 2006, the present application is amended as follows: